

Enhancement Mode N-Channel Power MOSFET

1.Features

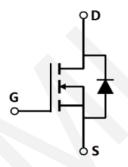
- ◆ Low R_{DS(ON)} & FOM
- ◆ Extremely low switching loss
- Excellent stability and uniformity

V _{DS}	$R_{DS(on)}$ Max.	I _D Max.
700V	1.4Ω @ 10V	4.7A

2.Applications

- PC power
- ◆ LED lighting
- ◆ Telecom power
- Server power
- ◆ EV Charger
- ◆ Solar/UPS





3.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Value	Units
Drain to Source Voltage	V _{DS}	700	V
Gate to Source Voltage	V _{GS}	±30	V
Drain Current (DC)	I _D	4.7	А
Drain Current (Pulse), PW≤300μs	I _{DP}	12.5	А
Total Dissipation	P _D	24	W
Avalanche Energy, Single Pulsed	E _{AS}	40	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

4. Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to case	R _{eJC}	5.2	°C/W
Junction to ambient	R _{0JA}	62.5	°C/W

Note 2: When mounted on 1 inch square copper board $t \le 10$ sec The value in any given application depends on the user's specific board design.



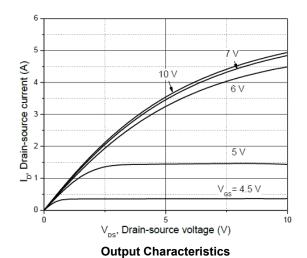
5.Electrical Characteristics at Ta=25°C (Note 3)

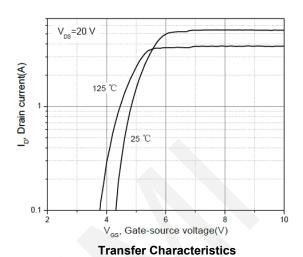
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250μA, V _{GS} = 0V	650	785		V
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V			1	μΑ
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±30V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _{DS} =250μA	2		5	V
Static Drain to Source On-State Resistance	R _{DS(on)}	I _D = 2A, V _{GS} = 10V	-	1.16	1.4	Ω
Input Capacitance	C _{iss}	V _{GS} =0V, V _{DS} =50V, Frequency=1.0MHz		263.2		pF
Output Capacitance	C _{oss}			18.8		pF
Reverse Transfer Capacitance	C _{rss}			0.83		pF
Turn-ON Delay Time	t _{d(on)}	$V_{DS} = 560V, I_{D} = 4A$ $V_{GS} = 10V, R_{G} = 25\Omega$		31.3		ns
Rise Time	t _r			17.4		ns
Turn-OFF Delay Time	t _{d(off)}			54.3		ns
Fall Time	t _f			36		ns
	Qg	V _{DS} = 560V, V _{GS} = 10V,		7.5		nC
Total Gate Charge	Q _{gs}			2.2		nC
	Q _{gd}	I _D = 4A		3.3		nC
Diode Forward Voltage	V _{FSD}	I _S = 5A, V _{GS} = 0		0.88	1.3	V

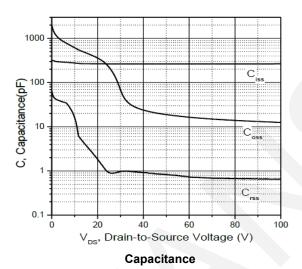
Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

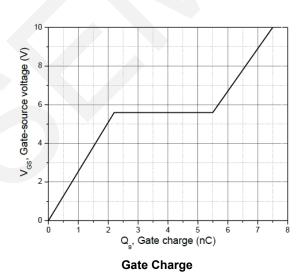


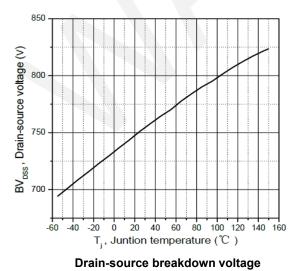
6. Typical electrical and thermal characteristics

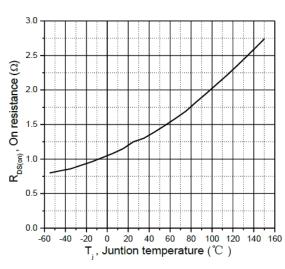






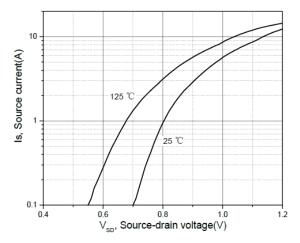




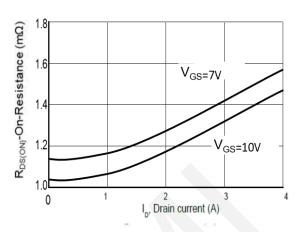


Drain-source on-state resistance

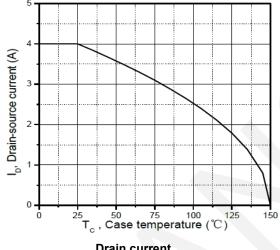




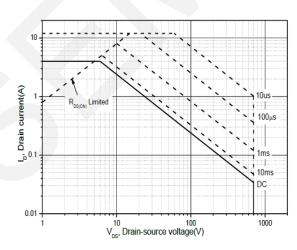
Forward characteristic of body diode



Drain-source on-state resistance



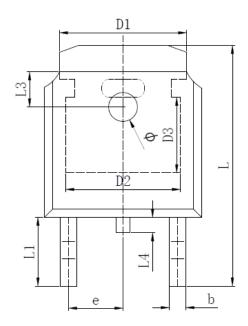
Drain current

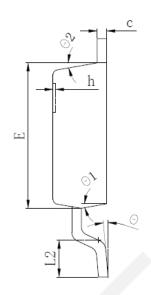


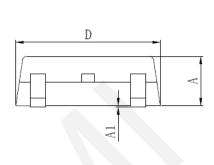
Safe operation area TC=25 °C



7.Package Dimensions







SYMBOL	MILLIMETER			
	MIN	Тур.	MAX	
A	2. 200	2. 300	2. 400	
A1	0.000		0. 127	
b	0.640	0.690	0.740	
c(电镀后)	0. 460	0. 520	0. 580	
D	6. 500	6. 600	6. 700	
D1	5. 334 REF			
D2	4.826 REF			
D3	3.166 REF			
E	6. 000	6. 100	6. 200	
е	2.286 TYP			
h	0.000	0.100	0. 200	
L	9. 900	10. 100	10. 300	
L1	2.888 REF			
L2	1. 400	1.550	1. 700	
L3	1.600 REF			
L4	0.600	0.800	1.000	
ф	1. 100	1. 200	1. 300	
θ	0°		8°	
θ1	9° TYP			
θ2	9° TYP			



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